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Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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2SB859

Silicon PNP Triple Diffused

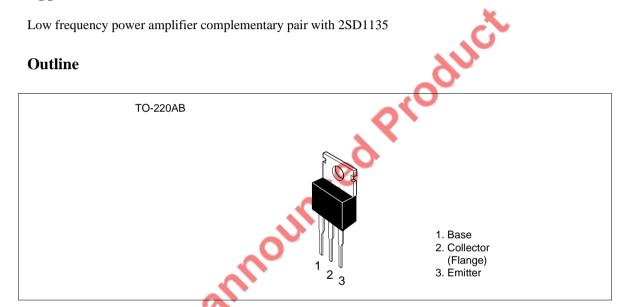


ADE-208-860 (Z) 1st. Edition September 2000

Application

Low frequency power amplifier complementary pair with 2SD1135

Outline



Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

Item	Symbol	Rating	Unit
Collector to base voltage	V _{CBO}	-100	V
Collector to emitter voltage	V _{CEO}	-80	V
Emitter to base voltage	V_{EBO}	- 5	V
Collector current	I _c	-4	A
Collector peak current	I _{C(peak)}	-8	A
Collector power dissipation	P _c *1	40	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-45 to +150	°C

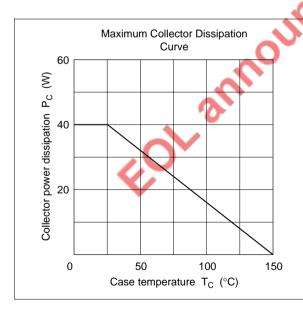
1. Value at T_C = 25°C Note:

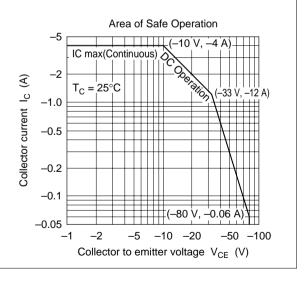
2SB859

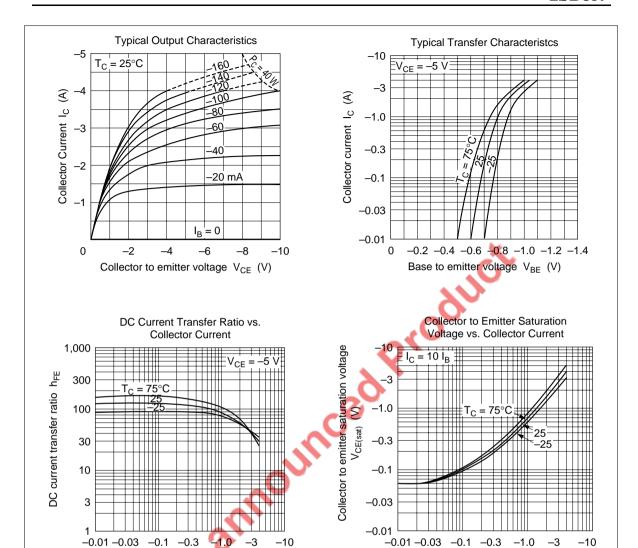
Electrical Characteristics ($Ta = 25^{\circ}C$)

Item		Symbol	Min	Тур	Max	Unit	Test conditions
Collector to voltage	emitter breakdown	$V_{(BR)CEO}$	-80	_	_	V	$I_{c} = -50 \text{ mA}, R_{BE} = \infty$
Emitter to ba	ase breakdown	$V_{(BR)EBO}$	- 5	_	_	V	$I_E = -10 \ \mu A, \ I_C = 0$
Collector cu	toff current	I _{CBO}	_	_	-0.1	mA	$V_{CB} = -80 \text{ V}, I_{E} = 0$
DC current transfer ratio		h _{FE1} *1	60	_	200		$V_{CE} = -5 \text{ V}, I_{C} = -1 \text{ A}^{*2}$
		h _{FE2}	35	_	_		$V_{CE} = -5 \text{ V}, I_{C} = -0.1 \text{ A}^{*2}$
Base to emi	tter voltage	V_{BE}	_	_	-1.5	V	$V_{CE} = -5 \text{ V}, I_{C} = -1 \text{ A}^{*2}$
Collector to voltage	emitter saturation	$V_{\text{CE(sat)}}$	_	_	-2	V	$I_{\rm C} = -2 \text{ A}, I_{\rm B} = -0.2 \text{ A}^{*2}$
Gain bandw	ridth product	f⊤	_	20	_	MHz	$V_{CE} = -5 \text{ V}, I_{C} = -0.5 \text{ A}^{*2}$
Collector ou	tput capacitance	Cob	_	75	_	pF ($V_{CB} = -20 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$
2.	The 2SB859 is grou Pulse test	iped by h _{fe}	, as follo	ows.	_<	540	
B					-0		
60 to 120	100 to 200			70			
Maximum Collector Dissipation Curve						Ar	ea of Safe Operation

В	С
60 to 120	100 to 200







Collector current I_C (A)

Collector current I_C (A)

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